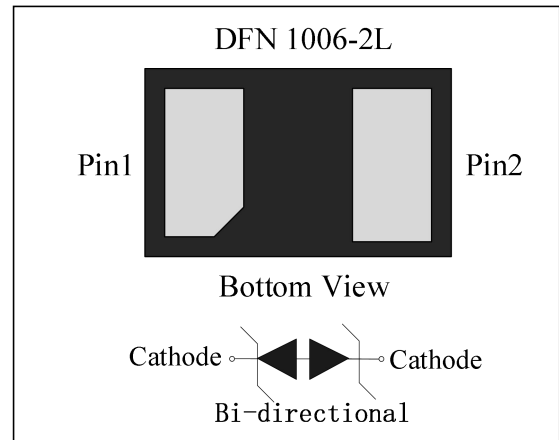


Power Transient Voltage Suppressor

Features

- Bi-directional ESD Protection of one line
- Working voltage:
3.3V、4.5V、5.0V、7.0V、12V、15V、18V、24V
- Epoxy Meets UL 94 V-0 Flammability Rating
- Low leakage current
- Transient protection for each line according to IEC61000-4-2 (ESD): $\pm 30\text{KV}$ (contact discharge)



Mechanical Characteristics

- Case: DFN 1006-2L package
- Packaging: Tape and Reel per EIA 481
- RoHS Compliant
- Markig Code

Applications

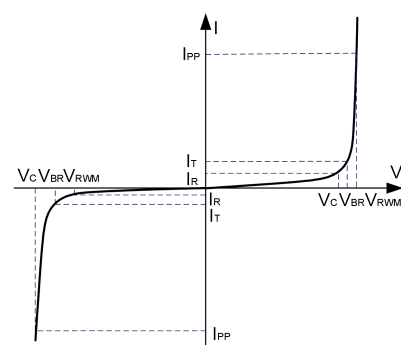
- MDDI Ports
- Cellular Handsets and Display Ports
- Computer and Peripherals

Absolute Maximum Rating(Ratings at 25 °C ambient temperature unless otherwise specified.)

Parameter		Symbols	Value	Unit
IEC61000-4-2 (ESD)	Air Model	V_{ESD}	± 30	KV
	Contact Model		± 30	
Junction Temperature Range		T_J	125	°C
Operating Temperature Range		T_{OPR}	-40 to +125	°C
Storage Temperature Range		T_{STG}	-55 to +150	°C

Electrical Parameter($T_c=25^\circ\text{C}$ Unless otherwise specified)

Symbol	Parameter
V_C	Clamping Voltage @ I_{PP}
I_{PP}	Peak Pulse Current
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_R	Reverse Leakage Current @ V_{RWM}
V_{RWM}	Reverse Standoff Voltage
V_F	Forward Voltage@ I_F



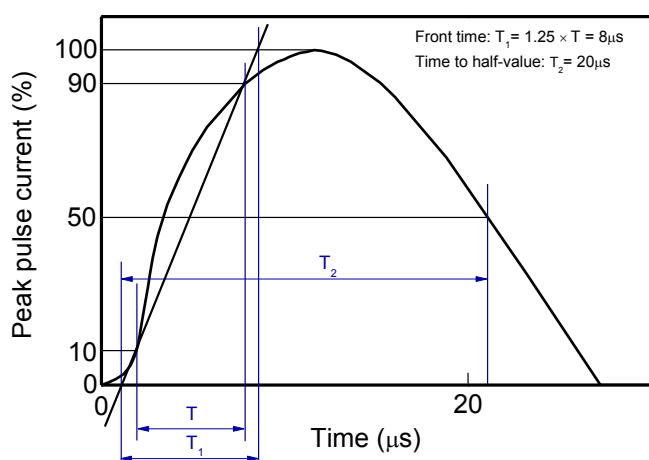
V-I characteristics for a Bi-directional TVS

Electrical Characteristics

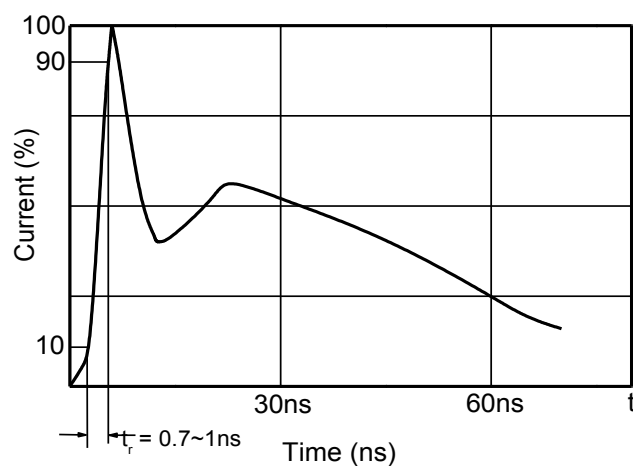
ESDB3V3ADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	3.3	V
Reverse Leakage Current at $V_{RWM} = \pm 3.3V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	5.0	--	6.5	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	48	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	6	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 6\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	7 10	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	12	16	pF
ESDB4V5ADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	4.5	V
Reverse Leakage Current at $V_{RWM} = \pm 4.5V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	4.8	--	6.0	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	--	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	--	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 9\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	--	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	--	--	pF
ESDB5VADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	5.0	V
Reverse Leakage Current at $V_{RWM} = \pm 5.0V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	5.8	--	8	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	100	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	8	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 8\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	9.5 15	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	12	15	pF
ESDB7V0ADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	7	V
Reverse Leakage Current at $V_{RWM} = \pm 7.0V$	I_R	--	--	0.2	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	7.6	--	9	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	72	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	6	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 3.5\text{ A}$, $t_p = 8/20\mu s$	V_C	--	9 12	12 16	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	15	16	pF
ESDB12VADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	12	V
Reverse Leakage Current at $V_{RWM} = \pm 12V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	13.3	--	16	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	84	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	3.5	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 3.5\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	13 24	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	--	9.5	pF

ESDB15VADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	15	V
Reverse Leakage Current at $V_{RWM} = \pm 15V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	16	--	19	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	280	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	8	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 8\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	22 35	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	--	45	pF
ESDB18VADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	18	V
Reverse Leakage Current at $V_{RWM} = \pm 18V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	20	--	24	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	210	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	10	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 6\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	25 35	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	--	40	pF
ESDB24VADB					
Parameter	Symbols	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}	--	--	24	V
Reverse Leakage Current at $V_{RWM} = \pm 24V$	I_R	--	--	0.1	μA
Breakdown Voltage at $I_T = 1\text{ mA}$	$V_{R(BR)}$	26.5	--	30	V
Peak Pulse Power Dissipation $t_p = 8/20\mu s$	P_{PP}	--	--	55	W
Peak Pulse Current $t_p = 8/20\mu s$	I_{PP}	--	--	5	A
Clamping Voltage at $I_{PP} = 1\text{ A}$, $t_p = 8/20\mu s$ at $I_{PP} = 5\text{ A}$, $t_p = 8/20\mu s$	V_C	--	--	38 51	V
Junction Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_J	--	--	32	pF

Typical Characteristics Curves



8/20 μs waveform per IEC61000-4-5

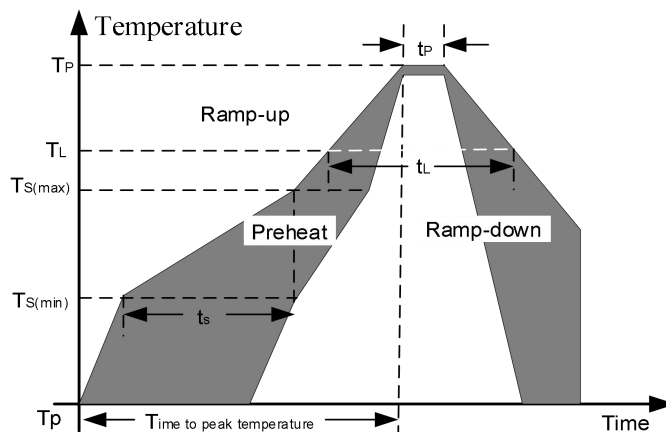


Contact discharge current waveform per IEC61000-4-2

Note: The above typical parameters or typical characteristics are only indicative and do not make specific guarantees. If detailed values are required, additional communication and provision are required.

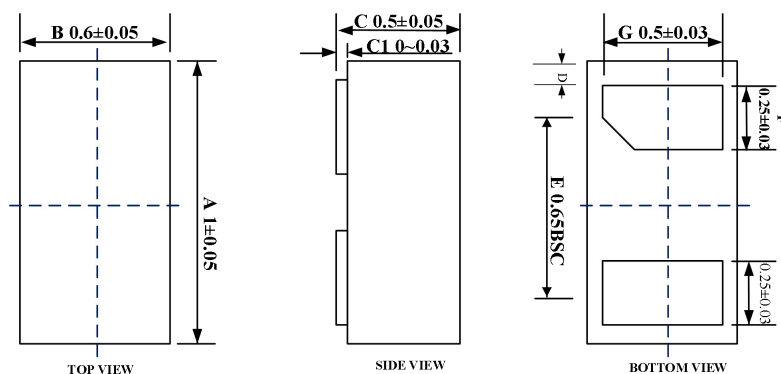
Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min (Ts(min))	150°C
	Temperature Max (Ts(max))	200°C
	Time (min to max) (ts)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (TL) to peak		5°C/second max
TS(max) to TL—Ramp-up Rate		5°C/second max
Reflow	Temperature (TL) (Liquidus)	217°C
	Temperature (tL)	60 – 150 seconds
Peak Temperature (TP)		260+0/-5 °C
Time within actual peak Temperature (tp)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (TP)		8 minutes Max.
Do not exceed		280°C



Outline Drawing – DFNx0.6-2L-0011

Dimensions in mm

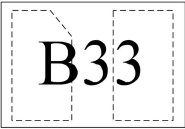
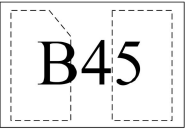

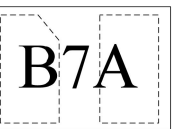
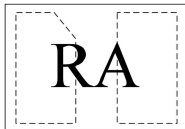

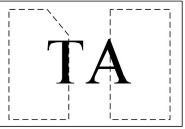



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.037	0.041	0.95	1.05	
B	0.022	0.026	0.55	0.65	
C	0.016	0.022	0.40	0.50	
C1	-----	0.004	-----	0.05	
D	0.001	0.003	0.02	0.08	
E	0.026		0.65		TYP.
F	0.008	0.012	0.20	0.30	
G	0.018	0.022	0.45	0.55	

Package Information

Package Type	Description	Quantity (pcs)	Standard
DFNX0.6-2L-0011	Tape & Reel -7" tape	10000	EIA-481

Part Marking System(Top View)

Device	ESDB3V3ADB	ESDB4V5ADB	ESDB5V0ADB	ESDB7V0ADB
DFN 1006-2L-0011				
Device	ESDB12VADB	ESDB15VADB	ESDB18VADB	ESDB24VADB
DFN 1006-2L-0011				

Contact Information

TANI website: <http://www.tanisemi.com> Email:tani@tanisemi.com

For additional information, please contact your local Sales Representative.



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Product Specification Statement

The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

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